

| ENGINEERING | PRODUCT SPECIFICATION | SPEC.NO.: | SPCS029A |
|-------------|--|-----------|----------|
| DEPT. | For CS59 Series Mini PCI Express Connector | PAGE: | 1/3 |

1. SCOPE:

This specification contains the test requirement of subject Connector when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202 MIL - STD - 1344 Methods for test of connectors for electronic equipment

Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CS59 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings

| REVIEWED :_ | David | APPROVED :_ | Eisley | VERIFIED :_ | Sun | |
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7. ELECTRICAL PERFORMANCE:

| | ITEM | TEST CONDITION | |
|-----|---------------------------|---|--------------------------|
| 7.1 | Rated current and voltage | | 0.5A 50V AC (r.m.s) |
| 7.2 | Contact resistance | Dry circuit of DC 20 mV max., 100 mA max. | Less than 55 m Ω |
| 7.3 | Dielectric strength | When applied AC 200 V 1minute between adjacent terminal | No change |
| 7.4 | Insulation resistance | When applied DC 500 V between adjacent terminal or ground | More than 500 M Ω |

8. MECHANICAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|-------------------------|--|--|
| 8.1 | Contact retention force | Push pin from insulator base at speed 25±3 mm per minute | More than 0.2 kgf |
| 8.2 | Insertion force | Mating speed 25 mm/minute | 2.3kgf max. |
| 8.3 | Withdrawal force | Unmating speed 25 mm/minute | 2.3kgf max. |
| 8.4 | Durability | 25 mating/unmating cycles | Contact resistance: Less than $40 \text{ m}\Omega$ |

9. ENVIRONMENTAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|------------------------------|---|--|
| 9.1 | Vibration | 1.5 mm 10-55-10 HZ/minute each 2 hours for X,Y and Z directions | Appearance: No damage Discontinuity: 1 micro second max. |
| 9.2 | Solderability | Soldering time: 5±0.5 second Soldering pot: 265±5°C | Minimum: 95% of immersed area |
| 9.3 | Resistance to soldering heat | Soldering time: 5±0.5 second Soldering pot: 260±5°C | No damage |
| 9.4 | Heat aging | 125±2°C, 96 hours | No damage |



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| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|---------------------|---|--|
| 9.5 | Humidity | 40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested | Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3 |
| 9.6 | Temperature cycling | One cycle consists of: (1)-40 +0 | Appearance: No damage Contact resistance: Less than twice of initial |
| 9.7 | Salt spray | Temperature: 35±3°C Solution: 5±1% Spray time: 48±4 hours Measurement must be taken after water rinse | Appearance: No damage Contact resistance: Less than twice of initial |

10. AMBIENT TEMPERATURE RANGE: -40 to +80°C